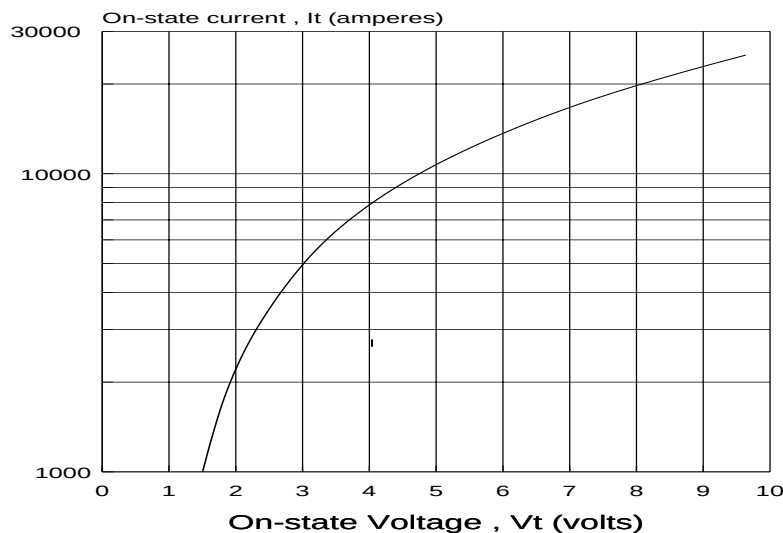
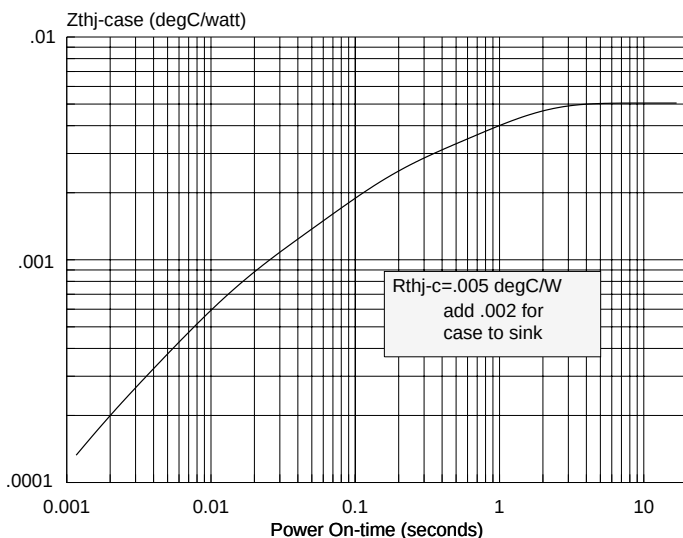


Type C792 thyristor is suitable for phase control applications such as for HVDC valves, static VAR compensators and synchronous motor drives. The silicon junction design utilizes a second generation pilot gate and a unique orientation of emitter shorts which promote the lateral expansion of conducting plasma resulting in lower spreading losses while achieving high dv/dt withstand. It is supplied in an industry accepted disc-type package, ready to mount using commercially available heat dissipators and mechanical clamping hardware.

MAXIMUM ON-STATE CHARACTERISTIC
Initial TJ=105 degC / 8ms pulse



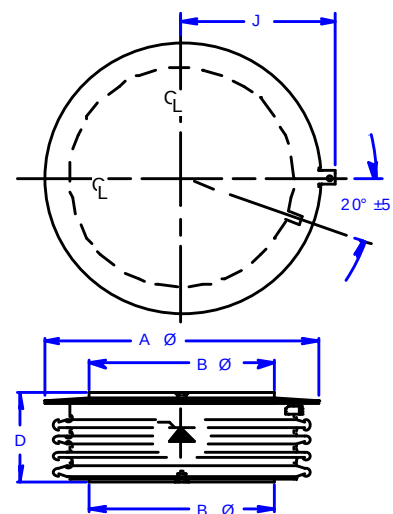
o1a:t305tau

**REPETITIVE PEAK REVERSE
AND OFF-STATE BLOCKING
VOLTAGE**

$T_J = 0 \text{ to } 115^\circ\text{C}$

MODEL	V_{DRM} (volts)	V_{RRM} (volts)
C792FP	6000	6000
C792ET	5900	5900
C792EN	5800	5800
C792ES	5700	5700
C792EM	5600	5600
C792EE	5500	5500

MECHANICAL OUTLINE



AF = 5.65 in (143.5 mm)
BF = 3.92 in (99.4 mm)
D = 1.45 in (36.8 mm)

**ELECTRICAL
CREEPAGE / STRIKE**
1.6 / 1.0 in
40.6 / 25.4 mm
CLAMPING FORCE
(range)
17000-19000 lb.

LIMITING CHARACTERISTICS AND RATINGS

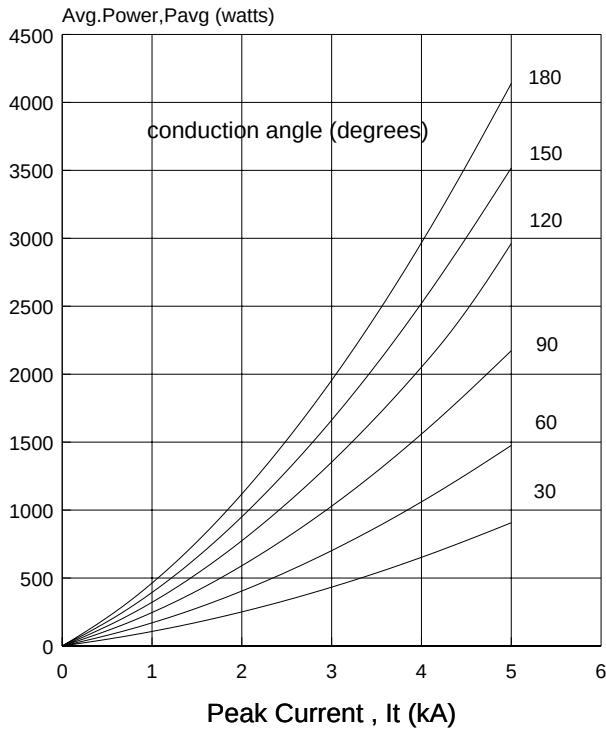
PARAMETER	SYMBOL	TEST CONDITIONS	MAXIMUM VALUES	UNIT S
Repetitive peak off-state and reverse voltage	V_{DRM} V_{RRM}	$T_j=0$ to $+115^{\circ}\text{C}$	see table	V
Repetitive working crest voltage	V_{DWM} V_{DRM}	$T_j=0$ to 115°C	$.8V_{DRM}$ $.8V_{RRM}$	V
Rep. off-state and reverse leakage current	I_{DWM} I_{RRM}	V_{DWM} V_{RRM} $T_j=115^{\circ}\text{C}$	150 150	ma ma
On-state Voltage	V_{TM}	$I_T=2000\text{A}$ $t_p=8.3\text{ms}$ $T_j=115^{\circ}\text{C}$	1.90	V
Critical DC gate current/voltage to trigger on	I_{GT} V_{GT}	$V_D=12\text{VDC}$ $T_j=25^{\circ}\text{C}$	150 3	ma V
Non-trigger gate current/voltage	I_{GD} V_{GD}	$V_D=.8V_{DRM}$ $T_j=115^{\circ}\text{C}$	8 —	ma V
Critical rate of rise of off-state	dv/dt	$0.67V_{DRM}$ $T_j=115^{\circ}\text{C}$	2000	V/us
Critical rate of of on-state	di/dt_{rep}	$0.67 V_{DRM}$ see req'd gating	100	A/us
Peak recovery current	$I_{RM(rec)}$	$di/dt=2\text{A/us}$ $T_j=115^{\circ}\text{C}$	118	A
Peak half-cycle non-repetitive surge current	I_{TSM}	$t_p=8.3\text{ms}$ $t_p=10\text{ms}$	35 34	kA
Circuit commutated turn-off time	t_q	$di/dt=5\text{A/us}$ $dv/dt=20\text{V/us}$	600	us

GATE CIRCUIT REQUIREMENTS

Open circuit voltage	40 - 50 V
Short circuit current	3 A minimum
Current risetime	0.5 us nominal
Pulse duration	10-20 us

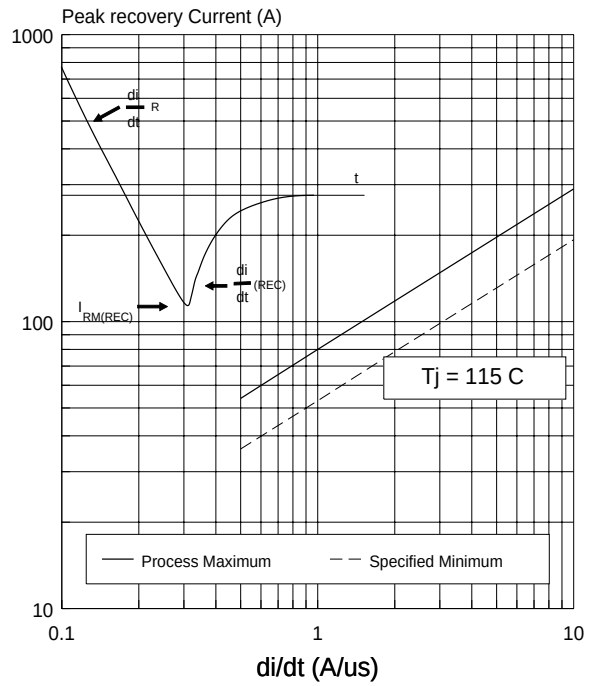
C792 / 6RT300

FULL CYCLE AVERAGE POWER DISSIPATION
Sine Wave-includes spread loss

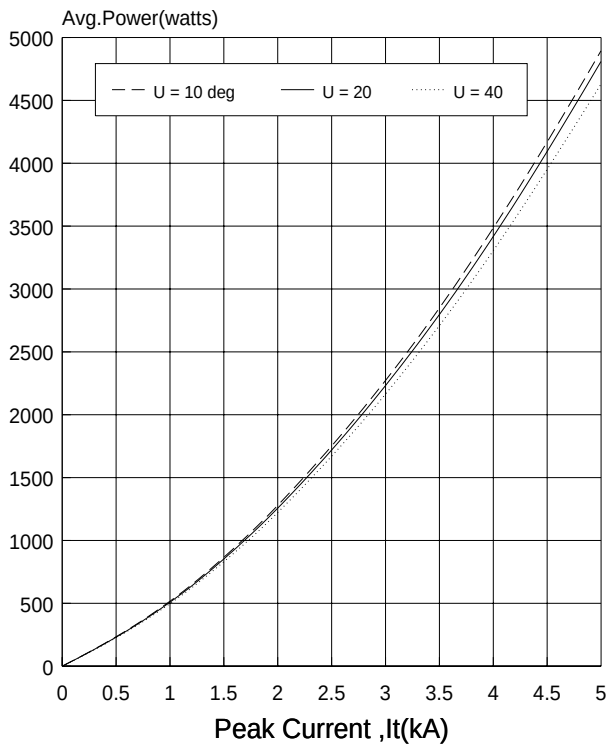


6RT300

PEAK RECOVERY CURRENT
versus
COMMUTATING di/dt

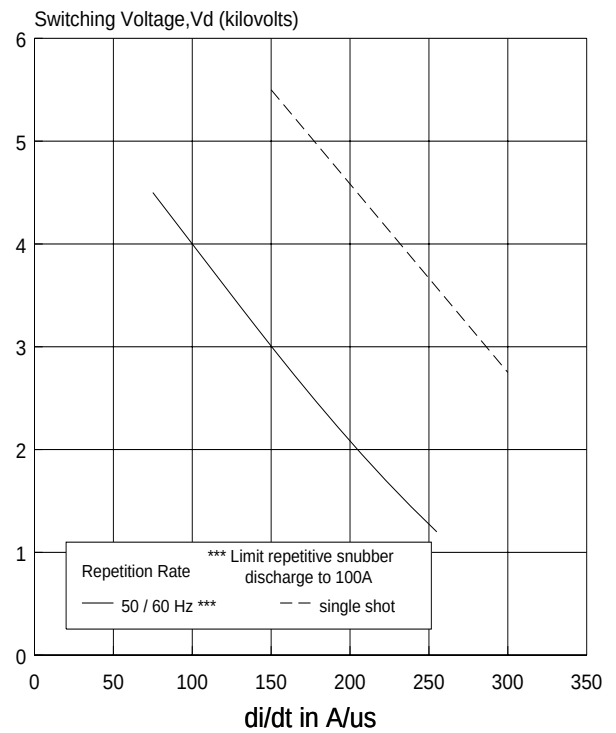


FULL CYCLE AVERAGE POWER DISSIPATION
120-Deg Conduction-includes spread loss
as a function of overlap angle, U



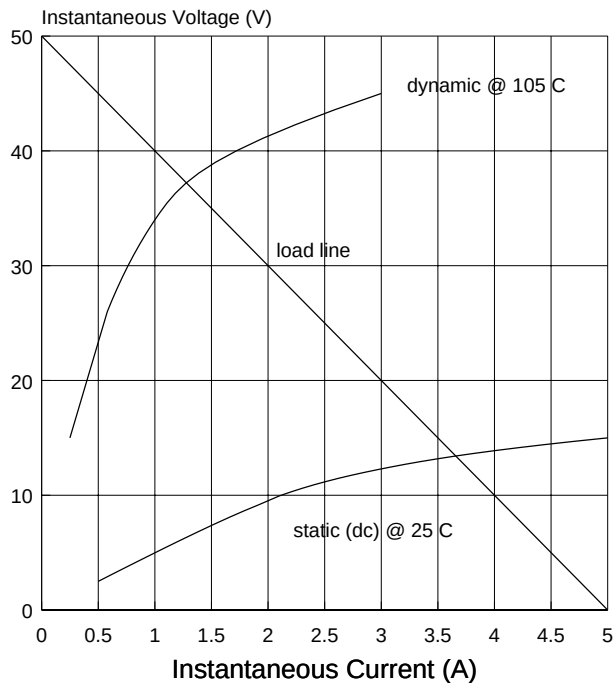
6RT300

INRUSH CURRENT (di/dt) RATING
versus
SWITCHING VOLTAGE



T300

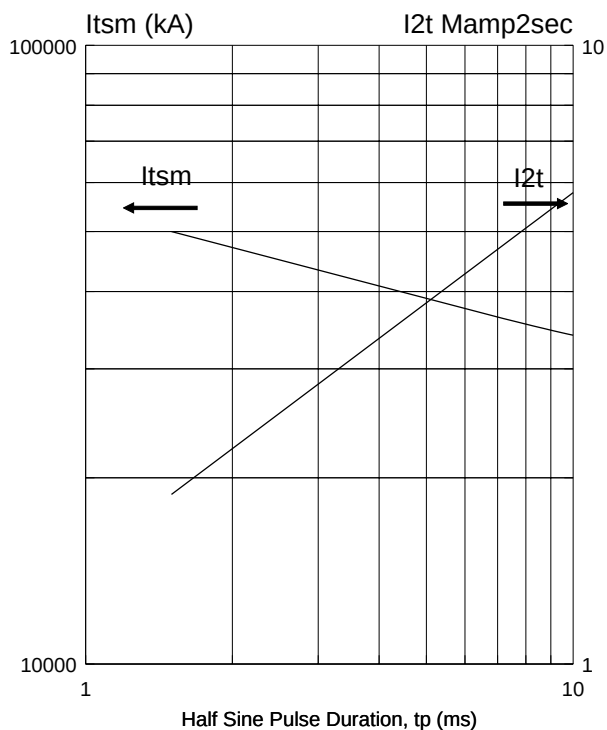
Gate Characteristics and Gate Supply Requirements



- THYRISTOR GATE IMPEDANCE**
 Enhanced by fast rising gate voltage, increasing anode bias and junction temperature. It is at a minimum for dc current, zero anode bias and low temperature.
- GATE SUPPLY**
 Prefer 50V/10 ohm for supporting the di/dt rating and life expectancy. The short circuit current risetime should be nominally 0.5us and the duration longer than the expected delay time for all magnitudes of anode bias. Practically 10-30us is recommended followed by a back porch of 750ma if needed to sustain conduction.
- MINIMUM ACCEPTABLE GATE CURRENT**
 The intersection of the load line and gate impedance characteristic indicates the minimum value of actual current needed during the delay time interval to support di/dt. A different load line meeting this criterion may be used.
- MAXIMUM GATE RATINGS**
 Peak gate power, $P_{gm}(100\mu s) = 300\text{ W}$
 Average gate power, $P_g(av) = 50\text{ W}$
 Peak gate current, $I_{gfm} = 25\text{ A}$
 Peak reverse voltage, $V_{grm} = 25\text{ V}$

T302

Non-Repetitive Surge Current and I2t for Fusing



01I:C792ITSM